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MEASUREMENT OF HIGH TEMPERATURE STRAIN BY THE LASER-SPECKLE STRAIN GAUGE

Ichirou Yamaguchi

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By using the laser-speckle strain gauge developed earlier and simplified now, the strain of metal at the temperature lower than 250°C is measured in a perfectly and automatic way. The principle of the gauge is to measure the expansion or contraction of the fine structures of surface by detecting the resultant speckle displacement in an optoelectronic way, whereby the effect of rigid-body motion is automatically canceled out with the aid of a differential detection system. We build a transportable apparatus and performed a comparison experiment with a resistance strain gauge at room temperature. It has a strain sensitivity of 2x10^-5, a gauge length smaller than 1 mm, and no upper limit in a range of strain measurement. In the measurement of high-temperature strain it is free from the need for a dummy gauge and insensitive to an electric drift effect. As examples of strain measurement at high-temperature, thermal expansion and contraction of a top of a soldering iron are measured. The interval of the measurement can be made at shortest 1.6 sec. and the change in the strain is clearly followed until the ultimate stationary temperature is reached.
Problems expected for measurement of higher temperature and reduction of the measurement interval are also discussed.
MEASUREMENT OF HIGH TEMPERATURE STRAIN BY THE
LASER-SPECKLE STRAIN GAUGE **

Ichirou Yamaguchi***

1. Preface

We have developed a method in which the surface strain of an irradiated region is found without any surface contact by automatically measuring the movement of the speckle pattern which occurs when the roughened surface was irradiated photo-electrically with a laser beam [1]. The characteristics of this strain gauge are that: (1) the influence of rigid body motion is eliminated automatically, and the longitudinal strain is directly obtained; (2) the sensitivity of the strain measurement is $10^{-5}$, and this is very high for an optical method; (3) since the gauge length is given by the laser beam diameter, it is taken as less than 1 mm. We made this portable type strain gauge for applications to specimens for which it is difficult to use resistance wires. We shall report on the basic principles of this strain gauge, and the results of measuring strain at high temperatures, for which this strain gauge was used.

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*** The Institute of Physical and Chemical Research
2. Basic principles

As a basic principle, this strain gauge has a close relationship with the diffraction grating strain gauge [2 - 5]. This strain gauge is for discovering a strain by detecting the change in the direction of diffracted light when diffraction intervals which were engraved on a mirror surface at regular intervals receive shrinkage from the surface strain and also by determining the change in the diffraction grating intervals. There are some examples of this strain gauge having been used for measuring strain at a high speed [2 - 4]. Also, although it is not a real time measurement, the distribution of strain is obtained if the distribution of the change of the diffraction grating intervals is measured by the distribution of the directions of diffracted light, by exposing a laser beam to each point of the negatives on which the image of a sample surface has been photographed and on which a diffraction grating is printed [6]. It is considered that a general roughened surface is a diffraction grating which has irregular and speckle is equivalent to what is called its diffracted speckle. Since the diffraction grating intervals are not constant, the space between the bands is not constant, and it is spatially distributed continuously and irregularly. Therefore, it is understood that the speckle moves by a displacement and a deformation of this irregular diffraction grating. Movement of the speckle by a displacement and a deformation of the surface, and the deformation which accompanies them is precisely analyzed by combining the theory of wave optics and the methods of correlation analysis [7]. The physical meaning of the derived relationship is simple. Namely, the movement of the speckle is equivalent to the movement of the diffracted light when a diffraction grating with certain equivalent intervals undergoes displacement and deformation. The diffraction grating intervals in this case are decided by the position of the center of curvature of the incident wave surface and the position of the observation point. On the
other hand, the speckle deformation occurs because the area of the roughened surface which is irradiated changes place. Therefore, not only the strain component but also the rigid body motion components (translation and rotation) generally overlap. However, (1) Take the difference of the speckle movement caused by each beam by irradiating the same point with two symmetrical beams, or (2) Take the difference of speckle movement at two symmetrical points by using a single beam [8]. By using either method, the effect of rigid body motion is automatically cancelled out, and only the component of the longitudinal strain is separated.

3. Optical distribution

Fig. 1 exhibits the layout which was used in this experiment. The method is to detect speckle movement at two points by using a single beam. A He-Ne laser is used and, depending on the reflectance of the samples, a 5 mW laser and an approximately 50 mW laser were properly used. The beam diameter at the samples which gives the gauge length can be adjusted freely depending on the lens. For the detection of speckle movement, the speckle is scanned by a one-dimensional semiconductor image sensor and the output is read on a microcomputer.

Fig. 1 Basic display of laser speckle strain gauge
and speckle movement is calculated as the peak position of the mutual correlation function between outputs around the area where strain arises. The laser beam and image sensor are set up in order to be coplanar. The beam is made to irradiate almost perpendicularly in order to maintain a uniform beam strength on both sensor surfaces. However, as is mentioned as follows, it is not necessary to be accurately perpendicular.

4. The retical relationships of speckle movement

The movement, which occurs in the speckle on the image sensor from the deformation of the specimen, is given in the following equations, if the incident beam and the surface made by the sensors are the x-z surface in the system of coordinates in Fig. 2.

\[ A_x = a \left( \frac{L_0 \cos^2 \theta_s + \cos \theta_v}{L_1 \cos \theta_v} \right) \]
\[ - a \left( \frac{L_0 \cos \theta_s \sin \theta_s + \sin \theta_v}{L_s \cos \theta_v} \right) \]
\[ - L_0 \left[ \epsilon_{ss} \left( \sin \theta_s + \tan \theta_v \right) \right] \]
\[ - Q \left( \cos \theta_v, 1 \right) \]

\[ A_y = a \left( \frac{L_0 + 1}{L_1} \right) - L_0 \left[ \epsilon_{ss} \left( \sin \theta_v + \sin \theta_v \right) \right] \]
\[ - Q \left( \cos \theta_s + \cos \theta_v \right) - Q \left( \sin \theta_s + \sin \theta_v \right) \]

where, \((a, a_x, a_\theta)\) describes the translation vector of the
irradiated area, \((\Omega_1, \Omega_2, \Omega_3)\) the rotation vector, \((\epsilon_{xx}, \epsilon_{yy}, \epsilon_{zz})\) the strain component. Also, \(\phi_0\) describes the angle of incidence of the beam, \(L_s\) the radius of curvature of the wave surface of the beam on the material surface, \(\beta_0, L_0\) is the angle made by the surface normal line and the sensor, and the distance between the irradiation point and the sensor.

If the difference between the speckle movements which are detected by the two sensors in Fig. 1 is taken, most of the terms in equation (1) are eliminated, and

\[
\Delta A_s = A_s(\theta_0) - A_s(-\theta_0) = -2L_s \epsilon_{xx} \tan \theta_0 - 2 \epsilon_{yy} \sin \theta_0 \tag{2}
\]

Namely, only the longitudinal strain \(\epsilon_{xx}\) which is parallel to the surface made by the sensor and the incident beam and the term parallel to the translation \(\Delta z\), which is perpendicular to the material surface, remain. Also, it does not depend on the angle of incidence \(\beta_0\), or on \(L_s\), which is determined by the lens power and the position in which it is inserted between the laser and the materials. Therefore, when \(\Delta s\) is sufficiently small, the strain value is obtained by using the following equation from \(\Delta A_s\) which is observed.

\[
\epsilon_{xx} = -\frac{A_s}{2L_0 \tan \theta_0} \tag{3}
\]

However, for the correlation peak of the output of the one dimensional sensors to appear clearly when the deformation given to the material is detected, the speckle motion component \(\Delta z\) which is perpendicular to the sensor must be sufficiently small. More accurately, it is necessary that \(\Delta z\) be smaller than the total of the mean diameter \(\Delta L_0\) \((\lambda : \text{ laser wavelength}; \omega : \text{ beam diameter})\) of the speckle on the sensor and the width of the sensor.
In the method which uses two symmetrical beams and a sensor, the difference of speckle movement does not receive the influence of 17 and is proportional to only \( \frac{k}{17} \). However, the arrangement becomes more complex, as a system which alternately irradiates the beams, etc., becomes necessary [1].

5. Detection of speckle movement

The image sensor which was used for this experiment was a RETICON RL 1728 H which is an MOS type photodiode array, and pitch was 15 \( \mu \)m, width was 14 \( \mu \)m, and number of elements was 1728. It is not necessary to use all of the output of the 1728 elements for the calculation of correlation, and a sufficiently clear correlation peak was obtained from around 512 elements. According to this, the correlation calculation time is greatly shortened. The output signal of the sensor is input to a microcomputer (LSI-11/2, 64 KB) by an A/D converter with clock 25 KH\( \_\_\_ \), 12 bit (DATEL-STLSI-2 is used). The correlation calculation was performed after this signal was made binary depending on whether or not it was above the mean level or below the mean level, and shortening the calculation time was performed.

6. Comparison experiment with a resistance wire strain gauge

The relationship mentioned above was experimentally confirmed by putting a 5 mW laser with 0.9 mm \( \frac{1}{e^2} \) diameter in the middle part of a brass specimen which has the standard configuration shown in Fig. 1 (length 100 mm, width of the neck 20 mm, thickness 1 mm) and applying a tension in the x direction. Surface treatments such as rough shear or painting, etc. were not performed on this specimen. A resistance wire strain gauge of 2 mm gauge length was put on the right backside of the beam spot, and the output was also entered in the microcomputer. Fig. 3 exhibits the output wave shapes (a) of both sensors before tension, (b) the output wave shapes after tension, and the mutual correlation function (c) between the wave shapes of each sensor.
Fig. 3. Output wave shapes of each image sensor (before loading (a) after loading (b) and mutual correlation function; (c) of wave shapes before and after loading).

The change of the strain by a resistance wire strain gauge in this case is 200 microstrain and the area of the correlation peak is proportional to it. In order to quickly perform the detection of the correlation peak position; first of all, the correlation function toward the shifting slide which was thinned is calculated.
and the maximum position is found among them. Next, only the region around the maximum position is calculated using small intervals and the final peak position is found.

![Graph showing strain measurement](image)

**Fig. 4.** The reading of the resistance wire strain gauge and speckle movement on each image sensor and the difference between them.

Figure 4 exhibits the values of the speckle movement obtained by stretching a portion of the specimen in 100 \( \mu \text{m steps} \) and adding up compared to the reading of the resistance wire strain gauge. The speckle movement on each sensor shows a complex action as the strain and the effects of rigid body motion differ depending on the position of each sensor. However, it is understood that the difference between is sufficient on the slope of the straight line which was calculated in Equation (3). However, it is considered that the reason why the straight line does not go through the origin is that the output of plane translation \( \phi \) shown in Equation (2) is large at the initial time when the load is applied.

7. Strain measurement at high temperatures

It became clear from the above experiment that this method functions as a noncontact strain gauge. The amount which is measured by this strain gauge is longitudinal strain itself which...
is defined geometrically as is shown in the theoretical analysis. Therefore, we considered an experiment using this method in the field, where it is difficult to use a resistance wire strain gauge. First of all, the strain from heated and cooled metals was chosen as an immediate subject, and as a subject in which the strain change is rather slow. Even if the specimen is at a high temperature, the strain as a total of thermal strain and mechanical strain can be measured by this strain gauge if the effects on the speckle movement of convection, etc. of the air can be ignored. The measurement time of this strain gauge is constrained by the correlation calculation time according to the method in which speckle movement is found every time as the above mentioned static strain measurement. For example, if the number of correlated points is 40, the measurement time is about 10 seconds.

In the case when deformation occurs continuously, such as the strain with a temperature change, the best way is that the output signal of the image sensor is read continuously into auxiliary memory, and the correlation function between the approximate data is calculated after summarizing them later. We took the method of writing the data, which was A/D converted to the floppy disk which belongs to the microcomputer. The sample intervals in this case are mainly determined by the writing speed of the disk. In the case when 750 elements of each sensor output are entered, the writing speed of the disk was about 4.3 sec.

As a subject, the strain from heating and cooling of the tip of a cylindrical surface of a 20W soldering iron was measured. Fig. 5 exhibits a picture of the equipment. The data for 80 repetitions can be written on a disk (capacity 1 MB). A thermocouple was installed at a position of about 1 mm from the edge of the irradiation spot, and the temperature was also entered into the computer at the same time. Since the reflectance of the surface of a soldering iron is low, an output of approximately 50 mW was used for the laser and, by using a lens of 300 mm focal length, a spot of about 2 mm diameter was focused on the measurement
Fig. 5. The measurement position of the high temperature strain of a soldering iron.

Fig. 6. Results of measurements of the temperature change of the tip of the soldering iron and the strain toward the axis of the soldering iron.

Fig. 7. Temperature of the tip of the soldering iron when it is heated and which is displayed on synchroscope, and the measurement results of the time change of strain toward the axis.
point. As is shown in Figure 5, the laser light source was not included in the strain gauge and the gauge was put on a portable type laboratory table with wheels. Since it was determined that light does not enter the image sensor except from the spot position, measurements can be performed in a bright room. Eight seconds after the soldering iron was turned on, the output of both sensors was input every 4.3 seconds.

Figure 6 exhibits the strain measurement results with respect to the axis of the soldering iron. In this case the value of the strain was directly calculated by Equation (3). No strain was found 20 seconds before the soldering iron was turned on; as temperature change was fast, the strain change was too large, and the clear correlation peak shown in Figure 3 (c) was not obtained. After this point was passed, the change of the strain became mild, and always a clear correlation peak began to occur. The temperature was found by inputting in a microcomputer after the terminal voltage of a copper constantan thermocouple maintained at zero degrees with ice water was amplified by direct current in order for the maximum value to become below 5V, and 12 bit A/D conversion was performed. It is considered that the reason why the temperature varies is that the contact condition of the thermocouple was incomplete. However, the value of strain always changed smoothly and it almost followed the mean temperature change. In this case the minimum strain change which it is possible to detect is that the difference of speckle movement is equivalent to the case which is equal to pitch 15 μm of the image sensor, and this is ΔAx microstrain in the current arrangement. On the other hand, the upper bound of the measurement range can be extended as much as we can by adding small changes as the above. However, in the case when the irradiation point begins drifting, it is necessary to adjust it by the proper method. According to the above method, the number of measurement points is constrained by the writing capacity of the floppy disk. As one of the methods of eliminating constraints, shortening the calculation time of the correlation
function has been considered. For phenomena such as strain by the temperature change, if sample intervals become short, speckle movement becomes small and the calculated point of correlation can be generally decreased. Therefore, a method was used in which 512 element of image sensor output is input to microcomputer and the peak was found by calculating the correlation with previous output with 12 points. In this case the intervals for samples were 5.2 sec. The temperature and the strain value in each step were written in the interval memory of the microcomputer and those time changes can be displayed on a synchroscope or record meter at the time when all the measurements have been finished. Figure 7 exhibits that the temperature and the strain measurement results toward the axis are displayed on the synchroscope, and the arm of the image sensor of the strain gauge was obtained parallel to the axis of the soldering iron. The soldering iron was turned on one minute after the beginning of the measurement, and it is perfectly understood that the soldering iron began expanding from that point.

Figure 8 exhibits the relationship between temperature and strain. The figure clearly shows the proportional relationship between temperature change and strain. The applied slope of the straight line is $22.9 \times 10^{-6}$. On the contrary, Fig. 9 exhibits the progress of strain after power was cut. The time when current was cut is also after one minute. The change of strain in this case is very smooth. Figure 10 exhibits the relationship between temperature and strain in this case.

Compared to Figure 8 the deviation from the straight line at high temperature and low temperature is conspicuous. Also, the slope of the straight line becomes $17.2 \times 10^{-6}$ and this is very different from the case of heating.
Fig. 8. The relationship between temperature and strain toward the measurement results of Figure 7.

Fig. 9. The temperature during cooling of the tip of the soldering iron displayed on synchroscope and the results of measuring the time change of strain toward axis.

Fig. 10. The relationship between temperature and strain toward the measurement results of Figure 9.
The following can be assumed from the above result. According to the Science Chronological Tables, the coefficient of linear expansion of copper for the material of the soldering iron is $16.7 \times 10^{-6}$. Therefore, in the case of heating, it is considered that $(22.9 - 16.7) \times 10^{-6} = 6.2 \times 10^{-6}$/deg is the mechanical strain from the thermal stress per $1^\circ$C. On the other hand, the mechanical strain in the case of cooling becomes $(17.2 - 16.7) \times 10^{-6} = 0.5 \times 10^{-6}$/deg. It shows that cooling is uniformly performed, and since the temperature gradient is small, almost no thermal strain by free contraction occurs. The circumferential strain can be measured if the arm of the image sensor is transversed to the arm of the soldering iron. Figure 11 exhibits one of the examples of the results of the heating.

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Figure 11. The temperature at heating of the tip of the soldering iron displayed on the synchroscope and the measurement result of the time change of circumferential strain.
A remarkable discontinuity which is considered to have occurred because of imperfect contact of the thermocouple is seen, but strain changes almost continuously. In our measurement result there is generally discontinuity in the strain change at the time of heating although the discontinuity is very small. On the other hand, almost no discontinuity was seen at the time of cooling. Therefore, it can be assumed that the cause of the discontinuity is not from oscillation of the strain gauge, etc. It is considered that correlation was probably insufficient and speckle movement on image sensor exceeded the 12 point correlation.

8. Examination

It has been reported that the examples of strain measurement at a high temperature by optical methods are ones for which the speckle interference method was used [9], the applications of the Moire method [10] and furthermore, the method for which digital image processing is used together with the Moire method [11], etc. In these methods, a two-dimensional distribution is obtained; on the other hand, it is difficult to find directly a strain value in real time, and strain sensitivity is about $10^{-4}$ at the highest. Printing a diffraction grating on the surface is necessary for the Moire method. It is not necessary to process the surface for the speckle interference method, but since the obtained diffraction pattern is the contour of the in-plane displacement, it must be differentiated. This method, which is basically a measurement of strain at every point, has the following characteristics. It is possible to find strain directly in a short time without any surface contact and the gauge length can be taken as less than 1 mm, with a strain sensitivity of approximately $10^{-5}$. The measurement temperature this time was less than approximately 250°C; but an experiment for higher temperatures has also been prepared. The problem of most concern in this case is the effect on the speckle movement of air convection.

If the gradient of the refractive index of the air changes, the speckle moves and, during the measurement, steps must be taken to control the changes in temperature gradient. For this, methods
of putting a specimen and an image sensor in an exhaust cell and removing the intervening air were considered. Also, in the case when the temperature becomes high and the specimen radiates if an interference filter is used for which wavelength is suitable for the laser light, speckle can only be set up with an image sensor by controlling the radiated component. Because of that, this method can be applied.

The surface for which this method can be used could be anything if it can diffusely reflect light. However, the case when the above speckle relationship is formed is when the fine structure of the measurement surface is sufficiently fine compared to the laser beam diameter. Even if a mirror reflection component occurs, such as from a smooth metallic surface, there is no problem since the speckle in the position where the mirror reflected light does not reach has a high contrast, and it moves according to the above rule. The samples which have been successfully measured so far are metals, rubber, paper, plastic and painted surfaces under ordinary temperature. However, it might be necessary for many samples to use a strong Ar laser, etc. rather than the He-Ne laser which was used in this experiment as the surfaces oxidize and the reflection rate decreases at high temperature. However, it is not necessary to also change the optical arrangement for that case, as the movement of speckle does not depend on the wavelength.

The minimum sampling interval in this experiment is about 1.65 seconds, by using a method of writing the outputs of image sensors in order on a floppy disk. In order to shorten the intervals easily, for examples, the output waveform of the image sensor is continuously stored in an analog data recorder. And later on, if the method of calculating speckle movement by reading the output waveforms gradually is taken, sample intervals can be moved to the 40 msec scan cycle of the image sensor. Furthermore, instead of calculating correlation by microcomputer the detection of speckle movement was made high speed by using an IC chip for calculation of the correlation, and calculating the repetitions of output of
a spatial filter photodector [12]. In the case when the spatial filter photodetector is used, it is necessary to decide the sign of speckle movement. The possibility of detecting the sign is being studied currently by performing a simulation experiment of the spatial filter detector by using image sensor and microcomputer.

Since shearing strain $e_{w}$ is effectively the same as in-plane rotation $\phi_{r}$, is not suitable for the measurement of shearing strain. (Refer to Equation (1)). Therefore, it becomes necessary for the general measurement of strain to put out arms of the image sensor in three directions like a rosette gauge, and the equipment becomes quite large scale. However, it might be possible to implement a rosette type system if the equipment can be made much smaller by using a semiconductor laser and fiberoptics which have been making rapid progress.

9. Conclusion

Strain below 250°C could be completely measured automatically by simplifying laser speckle which was previously developed, and by applying it to strain measurement at high temperature. Gauge length was 2 mm, strain sensitivity was about $2 \times 10^{-5}$. This strain gauge is for detecting the shrinkage of surface fine structure with light and for measuring itself, and a dummy gauge is not at all necessary. The shortest measurement time is 1.6 seconds with the current equipment. It is considered that this strain gauge can definitely be used up to 300°C. Problems which are considered for the measurement at higher temperature and also shortening the measurement time were also studied.

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